LQ022B8UD04

TFT-LCD Module

Spec. Issue Date: Dec. 27, 2003

No: LCY-303Z01

PREPARED BY: DATE	SHARP	SPEC No.	LCY-303Z01
		FILE No.	
APPROVED BY: DATE	MOBILE LIQUID CRYSTAL DISPLAY GROUP	ISSUE	Dec.27.2003
	SHARP CORPORATION	PAGE	Pages 22
	•	APPLICABLE	DIVISION
		MOBILE LCD	G DEPARTMENT III DESIGN CENTER I IID CRYSTAL DISPLAY
	SPECIFICATION		

DEVICE SPECIFICATION for TFT LCD Module

 $(176 \times RGB \times 220 \text{ dots})$

Model No.

 $LQ022B8\dot{U}D04$

ENTED Jamanus ()
fr' gantine
78
AKAZU.WADA

DIVISION DEPUTY GENERAL MANAGER ENGINEERING DEPARTMENT III MOBILE LCD DESIGN CENTER I MOBILE LIQUID CRYSTAL DISPLAY GROUP SHARP CORPORATION



RECORDS OF REVISION			DOC. First issue Model No.	Dec. 27. 2003 LQ022B8UD04
	<u>ILLCORDS C</u>	A TOP TABLETT	Spec. No.	LCY-303Z01
DATE	DATE REF.PAGE REVISED NO.		SUMMARY	CHECK AND APPROVAL
Dec.27.2003			First Issue	

- 10-0-10-1				



| SPEC No. | MODEL No. | PAGE | LCY-303Z01 | LQ022B8UD04 | 1

NOTICE

- o These specification sheets are the proprietary product of SHARP CORPORATION ("SHARP) and include materials protected under copyright of SHARP. Do not reproduce or cause any third party to reproduce them in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP.
- o The application examples in these specification sheets are provided to explain the representative applications of the device and are not intended to guarantee any industrial property right or other rights or license you to use them. SHARP assumes no responsibility for any problems related to any industrial property right of a third party resulting from the use of the device.
- The device listed in these specification sheets was designed and manufactured for use in Telecommunication equipment (terminals)
- o In case of using the device for applications such as control and safety equipment for transportation (aircraft, trains, automobiles, etc.), rescue and security equipment and various safety related equipment which require higher reliability and safety, take into consideration that appropriate measures such as fail-safe functions and redundant system design should be taken.
- o Do not use the device for equipment that requires an extreme level of reliability, such as aerospace applications, telecommunication equipment (trunk lines), nuclear power control equipment and medical or other equipment for life support.
- o SHARP assumes no responsibility for any damage resulting from the use of the device which does not comply with the instructions and the precautions specified in these specification sheets.
- o Contact and consult with a SHARP sales representative for any questions about this device.

[For handling and system design]

- (1) Do not scratch the surface of the polarizer film as it is easily damaged.
- (2) If the cleaning of the surface of the LCD panel is necessary, wipe it swiftly with cotton or other soft cloth. Do not use organic solvent as it damages polarizer.
- (3) Water droplets on polarizer must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.
- (4) Since this LCD panel is made of glass, dropping the module or banging it against hard objects may cause cracks or fragmentation.
- (5) Certain materials such as epoxy resin (amine's hardener) or silicone adhesive agent (de-alcohol or de-oxym) emits gas to which polarizer reacts (color change). Check carefully that gas from materials used in system housing or packaging do not hart polarizer.
- (6) Liquid crystal material will freeze below specified storage temperature range and it will not get back to normal quality even after temperature comes back within specified temperature range. Liquid crystal material will become isotropic above specified temperature range and may not get back to normal quality. Keep the LCD module always within specified temperature range.
- (7) Do not expose LCD module to the direct sunlight or to strong ultraviolet light for long time.
- (8) If the LCD driver IC (COG) is exposed to light, normal operation may be impeded. It is necessary to design so that the light is shut off when the LCD module is mounted.
- (9) Do not disassemble the LCD module as it may cause permanent damage.
- (10) As this LCD module contains components sensitive to electrostatic discharge, be sure to follow the instructions in below.
- (I) Operators

SPEC No.

LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

2

charge up and discharge. Equipment must be grounded through 100Mohms resistance. Use ion blower.

(3) Floor

Floor is an important part to leak static electricity which is generated from human body or equipment. There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the countermeasure (electrostatic earth: $1 \times 10^8 \Omega$) should be made.

(4) Humidity

Proper humidity of working room may reduce the risk of electrostatic charge up and discharge. Humidity should be kept over 50% all the time.

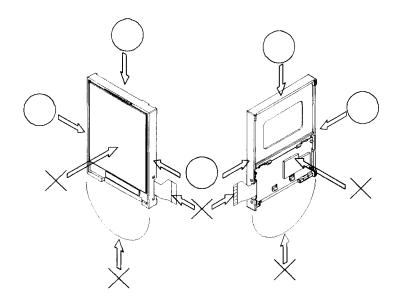
(5) Transportation/storage

Storage materials must be anti-static to prevent causing electrostatic discharge.

(6) Others

Protective film is attached on the surface of LCD panel to prevent scratches or other damages. When removing this protective film, remove it slowly under proper anti-ESD control such as ion blower.

- (11) Hold LCD very carefully when placing LCD module into the system housing. Do not apply excessive stress or pressure to LCD module. Do not to use chloroprene rubber as it may affect on the reliability of the electrical interconnection.
- (12) Do not hold or touch LCD panel to flex interconnection area as it may be damaged.
- (13) As the binding material between LCD panel and flex connector mentioned in 12) contains an organic material, any type of organic solvents are not allowed to be used. Direct contact by fingers is also prohibited.
- (14) When carrying the LCD module, place it on the tray to protect from mechanical damage. It is recommended to use the conductive trays to protect the CMOS components from electrostatic discharge. When holding the module, hold the Plastic Frame of LCD module so that the panel, COG and other electric parts are not damaged.



- (15) Do not touch the COG's patterning area. Otherwise the circuit may be damaged.
- (16) Do not touch LSI chips as it may cause a trouble in the inner lead connection.
- (17) Place a protective cover on the LCD module to protect the glass panel from mechanical damages.
- (18) LCD panel is susceptible to mechanical stress and even the slightest stress will cause a color change in background. So make sure the LCD panel is placed on flat plane without any continuous twisting, bending or pushing stress.



| SPEC No. | MODEL No. | PAGE | LCY-303Z01 | LQ022B8UD04 | 3

peeling off this protective film. Ion blower and ground strap are recommended.

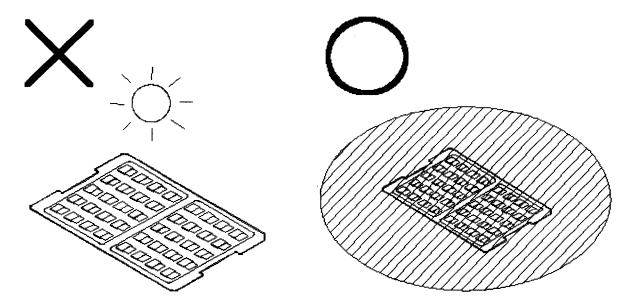
- (20) Make sure the mechanical design of the system in which the LCD module will be assembled matches specified viewing angle of this LCD module.
- (21) This LCD module does not contain nor use any ODS (1,1,1-Trichloroethane, CCL4) in all materials used, in all production processes.

[For operating LCD module]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) Do not display still picture or the display over 2 hours as this will damage the liquid crystal.
- (3) As opto-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

[Precautions for Storage]

- (1) Do not expose the LCD module to direct sunlight or strong ultraviolet light for long periods. Store in a dark place.
- (2) The liquid crystal material will solidify if stored below the rated storage temperature and will become an isotropic liquid if stored above the rated storage temperature, and may not retain its original properties. Only store the module at normal temperature and humidity (25±5°C, 60±10%RH) in order to avoid exposing the front polarizer to chronic humidity.
- (3) Keeping Method
 - a. Don't keeping under the direct sunlight.
- b. Keeping in the tray under the dark place.



- (4) Do not operate or store the LCD module under outside of specified environmental conditions.
- (5) Be sure to prevent light striking the chip surface



SPEC No. LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

4

[Other Notice]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) As electrical impedance of power supply lines (VEE-VSS, VDD-VSS) are low when LCD module is working, place the de-coupling capacitor near by LCD module as close as possible.
- (3) Reset signal must be sent after power on to initialize LSI. LSI does not function properly until initialize it by reset signal.
- (4) Generally, at power on, in order not to apply DC charge directly to LCD panel, supply logic voltage first and initialize LSI logic function including polarity alternation. Then supply voltage for LCD bias. At power off, in order not to apply DC charge directly to LCD panel, execute Power OFF sequence and Discharge command.
- (5) Don't touch to PWB surface, exposed IC chip, electric parts and other parts, to any electric, metallic materials.
- (6) No bromide specific fire-retardant material is used in this module.
- (7) Because including CMOS in this model, there is possibility that this module works wrongly by the noise from the antenna and so on. Please implement enough shields on user's product.

[Precautions for Discarding Liquid Crystal Modules]

COG : After removing the LSI from the liquid crystal panel, dispose of it in a similar way to circuit boards from electronic devices.

LCD panel: Dispose of as glass waste. This LCD module contains no harmful substances. The liquid crystal panel contains no dangerous or harmful substances. The liquid crystal panel only contains an extremely small amount of liquid crystal (approx.100mg) and therefore it will not leak even if the panel should break.

PWB/FPC: Dispose of as similar way to circuit board from electric device.

SPEC No.

MODEL No. LCY-303Z01

LQ022B8UD04

PAGE

5

	Contents		Page
I	Notice		1
П	Contents	• • • • • • • • • • • • • • • • • • • •	5
1	. Application		6
2	2. Construction and Outline		6
3	. Mechanical specification	• • • • • • • • • • • • • • • • • • • •	6
4	Absolute Maximum Ratings		7
	(4-1) Electrical absolute maximum ratings		7
	(4-2) Environment Conditions		7
5	. Electrical specification		8
	(5-1) Electrical characteristics		8
	(5-2) LED back light	.,	9
	(5-3) Interface signals		10
	(5-4) Host Interface timing		11~12
	(5-5) Electrical Schematics of LCD		13
	(5-6) Power ON/OFF sequence		14~15
6.	Optical characteristics		16~18
7.	Lot Number identification		19
8.	Packing specifications		19
	(8-1) Details of packing		19
	(8-2) Reliability		19
	(8-3) Packing quantities		20
	(8-4) Packing weight		20
	(8-5) Packing outline dimensions		20~21
9.	LCD module outline		22



SPEC No. LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

6

1. Application

This data sheet is to introduce the specification of LQ022B8UD04, active matrix 262,144 colors LCD module.

The LCD module controlled by Driver ICs (LR38825 / LH169CH).

If any problem occurs concerning the items not stated in this specification, it must be solved sincerely by both parties after deliberation.

As to basic specification of driver IC refer to the IC specification and handbook.

2. Construction and Outline

Construction: LCD panel, Driver (COG), FPC with electric components,

4 pieces White LED lump, prism sheet, diffuser, light guide and reflector, plastic frame to fix them mechanically.

Outline: See Fig.12 (page 22).

Connection: 35 pins; 0.3mm pitch ZIF FPC connector. Correspondable connector: FF02B35SS1 (JAE)

3. Mechanical Specification

Table 1

	Dorometer	Specifications	Unit
Parameter Outline dimensions *1			Cint
		$42.1 \text{ (W)} \times 56.6 \text{ (H)} \times 4.2 \text{ (D)}$	mm
LCD	Active area	34.848 (W) × 43.56 (H)	, mm
Panel Display format	Display format	176×RGB(W)×220(H)	-
	Dot pitch	0.066 (W) ×0.198 (H)	mm
	Base color *2	Normally white	-
Mass		Approx 12.1	g

^{*1} See Fig.12 (page 22)

^{*2} Due to the characteristics of the LC material, the colors vary with environmental temperature.



SPEC No. LCY-303Z01

MODEL No.

30

LQ022B8UD04

mA

PAGE

7

4. Absolute Maximum Ratings

(4-1) Electrical absolute maximum ratings

		Table 2		T	a=25°C
Parameter	Symbol	Min	Max	Unit	Remark
Supply voltage for LCD	VEE-VSS	-0.3	4.0	V	VEE
Supply voltage for Logic	VDD-VSS	-0.3	4.0	V	VDD
Input Voltage	V _{IN}	-0.3	VDD+0.3	V	*1

0

 I_{LED}

(4-2) Environment Conditions

LED forward current

Table 3

Item	Тор		p Tstg		Remark	
	MIN.	MAX.	MIN.	MAX.		
Ambient temperature	-10 °C	+60°C	-20 °C	+70°C	Note 2)	
Humidity	Note 1)				te 1)	No condensation

Note1) Ta ≤ 40 °C......95 % RH Max

Note2) Ta > 40 °C......Absolute humidity shall be less than Ta=40 °C /95 % RH.

As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable. Be sure not to exceed the rated voltage, otherwise a malfunction may occur.

^{*1} Input terminal of logic system. : Voltage value is based on VSS = 0V.

^{*2} See (5-2) LED back light (page 9)



LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

8

5. Electrical Specifications(5-1) Electrical characteristics

Ta=25°C, VEE=3.0V, VDD=3.0V, VSS=0V Table 4 Applicable Symbo Unit Max. Conditions Min. Тур. Parameter Pin 1 VEE-3.2 V **VEE** 3.0 Ta=-10~60 °C 2.8 Supply voltage for LCD VSS VDD-VDD V 3.6 Ta=-10~60 °C 1.7 3.0 Supply voltage for Logic **VSS** 0.7VDD V "H" level input voltage V_{IH} (note1) Ta=-10~60 °C V 0.3VDD V_{lL} "L" level input voltage "H" level Input leakage 10 μΑ I_{IH} Ta=-10~60 °C current (note2) $V_{IN} = VSS \text{ or } VDD$ "L" level Input leakage μΑ -10 I_{lL} current V Ta=-10~60 °C 0.8VDD V_{OH} "H" level output voltage (note3) V $I_{OH} = -100 \mu A, I_{OL} = 100 \mu A$ 0.2VDD V_{OL} "H" level output voltage 8.0 mA 5.5 Current consumption for LCD I_{EE} (note4) Ta=25 °C Current consumption for 2.0 10.0 μΑ I_{DD}

(note1) /WR, /CS, RS, /RD, /RES, D0~D15

(note2) /WR, /CS, RS, /RD, /RES, D0~D15

(note3) LCDINT

Logic

(note4) Following Conditions

Ta=25 °C, VDD=3.0V, VEE=3.0V, Frame frequency = 80Hz

Display Pattern: All Black. No Host CPU access.

*All Black pattern





LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

9

(5-2) LED back light

(1) At LCD panel, the back light use 4pieces white LED.

Table 5

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remark
Forward current	I _{LED}	Ta=25 °C	-	20	30	mA	CA

LED maker : NICHIA Corporation

: NSCW335T LED type

*Please consider Allowable Forward Current on used temperature (refer to Ambient Temperature vs. Allowable Forward Current curve)

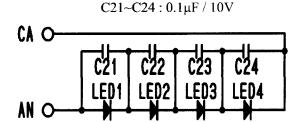


Fig.1 LED circuit

Ambient Temperature vs. Allowable Forward Current

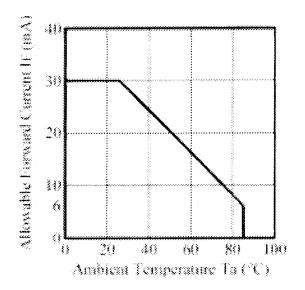


Fig.2 Ta vs. IF (NSCW335T)

EXPECIFICATIONS

Li Absolute Maximum Ratings		<u>Table 6</u>	(12-250)
Hen	Symbol	Absolute Maximum Rating	Cast
Forward Centent	lj:	39	mA
Palse Ferward Corpor	1177	(31)	sεA
Revese Voliage	Ya	\$	¥
Prescribissipation	Pa	120	m.W

ize Conditions

Palse Whith S. Hensee, and Daily S. 1/19

(Difficial Electrical Optical Charm	icristics	Table 7			()	(a-25°()
	ilve:	Ny sistemi	10 21 1	1	13.33	Max	l su:
	ingward Volinge	¥	$b = 20 (m \Lambda)$, ×.	કે છે	4.0	V
	Всуста: Свисв	3 22	Van SIV	A	÷.	30	31.4



MODEL No.

LQ022B8UD04

PAGE

10

(5-3) Interface signals

Table 8

LCY-303Z01

		<u>Table 8</u>		
Pin No	Symbol	Description	I/O	Remark
1	VSS	Ground level pin	-	-
2	VSS	Ground level pin	-	-
3	VEE	VEE level pin	-	For LCD driving
4	D15	Data Bus (MSB)	I/O	(Note 1)
5	D14	Data Bus	I/O	(Note 1)
6	D13	Data Bus	I/O	(Note 1)
7	D12	Data Bus	I/O	(Note 1)
8	D11	Data Bus	I/O	(Note 1)
9	D10	Data Bus	I/O	(Note 1)
10	D9	Data Bus	I/O	(Note 1)
11	D8	Data Bus	I/O	(Note 1)
12	VSS	Ground level pin	_	-
13	D7	Data Bus	I/O	
14	D6	Data Bus	I/O	
15	D5	Data Bus	I/O	
16	D4	Data Bus	I/O	
17	D3	Data Bus	I/O	
18	D2	Data Bus	I/O	
19	D1	Data Bus	I/O	
20	D0	Data Bus (LSB)	I/O	
21	VSS	Ground level pin	_	
22	VSS	Ground level pin	-	
23	/WR	Write control input pin	I	"L" active
24	RS	Register select pin	I	
25	/CS	Chip select input pin	I	"L" active
26	/RES	Reset signal input pin	I	"L" active
27	VDD	VDD level pin	-	For Logic driving
28	LCDINT	Interrupt request to the host bus	0	(Note 2)
29	/RD	Read control input pin	I	"L" active
30	IFM0	Selection signal pin for host interface mode	I	L RS "H" : commands H RS "L" : commands
31	BUS0	Selection signal pin for the width of data bus	I	L 8bit bus interface H 16bit bus interface
32	AN	LED back light for (Anode)	_	-
33	AN	LED back light for (Anode)	-	_
34	CA	LED back light for (Cathode)	-	-
35	CA	LED back light for (Cathode)	_	-

Used connection: 0.3mm pitch ZIF FPC connector.

Correspondable connector: FF02B35SS1 (JAE)

(Note 1) For unused Data Bus, connect to VSS.

(Ninta 3) If James was "I CININITY min languist amon

SPEC No. LCY-303Z01 MODEL No.

LQ022B8UD04

PAGE

11

(5-4) Host Interface Timing

(1) Write

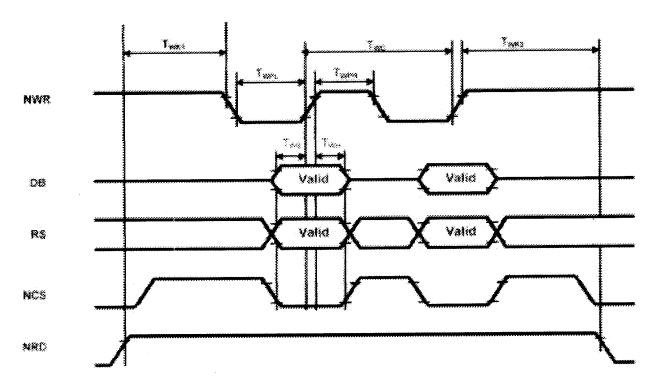


Fig.3 Host interface timing (Write)

Table 9

Symbol	Description	Min.	Max.	Note
Y yar	Low period of NVVI	60 m		
T _{we} .,	High period of NVX	80 ms		
Tasc	Prohibit time re-writing	140 ms		
~.v.s	Set up time of CB, RS and NCS to the NVR dsing.	50 ms		
Tasan	Highlitime of DB. RS and NCS to the NV/R dising	បិកទេ	~	
1,000	Required time from the read cycle to write cycle	300 ns	200000000000000000000000000000000000000	000000000000000000000000000000000000000
\$286.3	Required time from the write cycle to read cycle	300 ms	v	

SPEC No. LCY-303Z01 MODEL No. LQ022B8UD04 PAGE

12

(2) Read

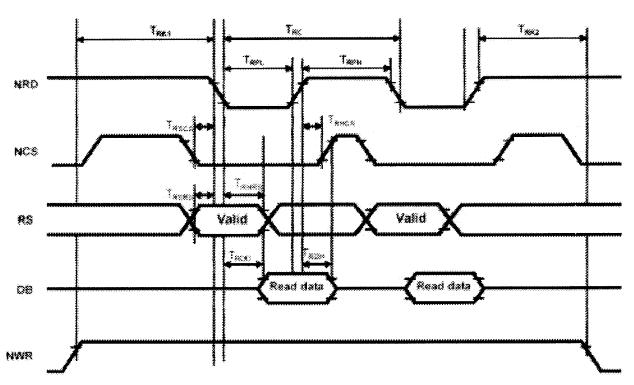


Fig.4 Host interface timing (Read)

Table 10

Symbol	Description	Min.	Max.
(m/s	Low period of NRO	100as	
- ALPHA	High period of NRD	100ms	-
Tac	Prohibition line for re-reading	200ns	
Tages	Set up time of RS to NRC falling	5(m)	w
Tescs	Set up time of NCS to NRO falling	50%	26
20.203	Hold time of RS from NRD falling	50ns	
89003	Hold time of NCS from NRD rising	50ns	
¥ 66 (30)	Time from NRO fating to confirmation of DE output		80ns
Tacos	Time from NRO vising to confirmation of DB output	Sms	

Conditions V_{CDCC} * 1.65 V to 3.3 V, V_{CDCC} * 1.8 ±0.15 V, Tops * - 30°C to *70°C, C₁ * 16 pF Reference input voltage V_{CF} = 0.9 V_{CDC} V_{CF} = 0.1 V_{CDC} Reference output voltage: V_{CF} = 0.9 V_{CDC} V_{CF} = 0.1 V_{CDC}

SPEC No. LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

13

(5-5) Schematic of LCD module system

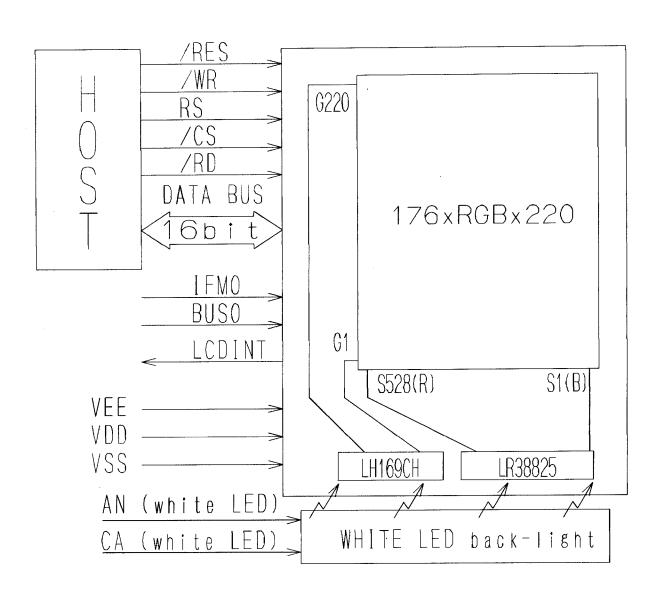


Fig.5 Schematic of LCD module system



LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

14

(5-6) Power ON/OFF sequence

(1) Power ON

Table 11

		<u> Table 11</u>		
Register	Command	Remarks		
FD	FD	Software reset		
FD	FD			
		WAIT (Min 50ms)		
E0	01	Gate reset		
		WAIT (Min 5μs)		
E0	00	Gate reset release		
FE	FE	Host reset		
FE	FE			
EE	00	EEPROM I/F ready [Note]		
		WAIT (Min 10ms)		
EF	00	CPU bank active		
10	08	Host Interface setting register (1)		
12	AF	VRAM access area setting register (X direction/start and pointer)		
13	DB	VRAM access area setting register (Y direction/start and pointer)		
15	00	VRAM access area setting register (X direction/end)		
16	00	VRAM access area setting register (Y direction/end)		
18	03	Address auto increment setting register		
88	00	Display displaying color setting register		
7E	04	Display displaying setting register		
		WAIT (Min 20ms)		
7E	05	Display displaying setting register		
7F	01	V sync parameter transfer flag		
		[Write VRAM]		
80	01	Display displaying control register (DIPS ON)		

[Note]

A setup peculiar value to a panel is written in EEPROM.

[Cautions] Please do not rewrite



LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

15

(2) Power OFF

Table 12

Register	Command	Remarks		
EF	00	CPU bank active		
1B	04	Host reset enable		
FE	FE	Host reset		
FE	FE			
7E	04	Display setting		
E3	04	Dc setting		
E4	04	Dc setting		
E2	01	Oc off setting		
80	00	Display Off		
E0	01	Gate reset		
7F	01	ΓG parameter refresh		
		WAIT (MIN 5 μ s)		
E0	00	Gate reset release		
7F	01	TG parameter refresh		
		WAIT (MIN 5μ s)		
01	01	Oscillator stop		
		[Power off]		



SPEC No. LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

16

6. Optical Characteristics

Table 13

 $Ta = 25^{\circ}C$

					<u>Table 13</u>				1a =25°C
Mode	parameter		symbol	conditio	MIN	TYP	MAX	unit	Remark
				n					
Tra	Brightness		В	θ=0°	35	50	-	cd/m ²	Note 1,2
msm	Contrast		Co	θ=0°	40:1	60:1	_		Note 1,3
Brightness Contrast Viewing Angle		θу-	Co > 5	20	30	_	deg	Note 1	
ě	•		$\theta y+$		20	30	-		
			θx-		20	30	_		
			θx+		20	30	-		
	Response	Rise	τιι	θ=0°	_	18	35	ms	Note 1,4
	Time	Decay	τdl		-	45	75	ms	
	White chroma	ticity	X	θ=0°	-	0.31	-		Note 1,3
			у		-	0.35			
Ref	Reflectance		Rf	θ=0°	•	11	-	%	Note 5
Reflective	White chromaticity		X	θ=0°	_	0.30	no.		Note 5
ive			y		-	0.34	-		

Note 1) Definition of range of visual angle

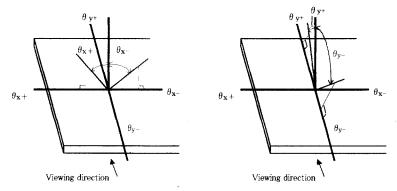


Fig.6 Definition of viewing angle

SPEC No.

LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

17

Note 2) Brightness is measured as shown in Fig.7, and is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.

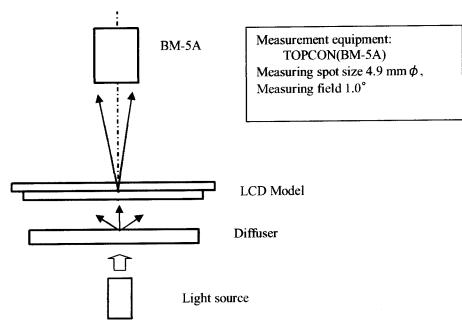


Fig.7 Optical characteristics Test Method (Brightness)

Note 3) Contrast ratio is defined as follows:

Co= Luminance(brightness) all pixcels "White"

Luminance(brightness) all pixcels "dark"

Note 4) Response time is defined as follows:

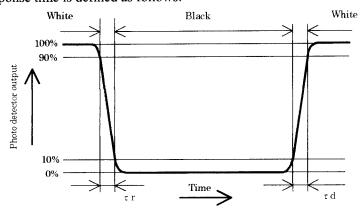


Fig.8 Response time (TFT)

SPEC No.

LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

18

Note 5) Reflectance is defined as follows:

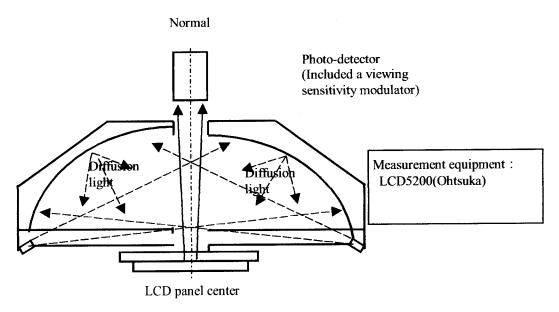


Fig.9 Optical Characteristics Test Method

SPEC No.

LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

19

7. Lot Number identification

Lot numbering and location are specified as follows.

000001

Dproduct year (lower 2 digits)

03:2003, 04:2004

2 product month

A:JANUARY,B:FEBRUARY,C:MARCH.....L:DECEMBER

(3)Serial number

000001 ~ 999999

(4) Record of Revision

A:The first edition, B:Second edition

5product maker

SC:SHARP

- 8. Packing specifications
 - (8-1) Details of packing
 - 1) Packing materials: Table.15
 - 2) Packing style

:Fig.11

(8-2) Reliability

1) Vibration test

Table 14

VIDIUION WEST		10010.1				
Item		Test				
Frequency		5 Hz to 50 Hz ((3 minutes cycle)			
Direction	Up-l	Down, Left-Right, l	Front-Back (3 direct	ions)		
Period	Up-Dow	Left-Right	Front-Back	Total		
	60min	15min	15min	90min		

The frequency should start at 5 Hz and vary continuously.

Total amplitude

20mm

0.2mm

20mm

5Hz

0

0.2mm 50Hz

Frequency

5Hz 0

0

50Hz

(For 9.8m/s²)

3 minutes

2) Drop test

Drop height:

750mm

SPEC No.

MODEL No. LCY-303Z01

LQ022B8UD04

PAGE

20

(8-3)Packing quantities

250 modules (max) per master carton

(8-4)Packing weight

About 7.7kg

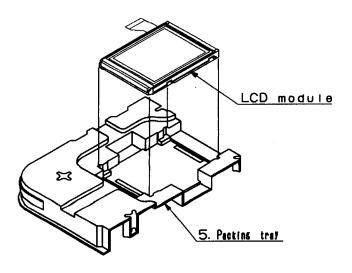
(8-5)Paking outline dimensions

382mm × 578mm × 255mm

(Packing materials)

 $\underline{\text{Table.}15}$

	Parts name	Materials	
1	Master carton	Corrugate card board	
2	Under pad	Corrugate card board	
3	Inside sleeve	Corrugate card board	
4	Outside sleeve	Corrugate card board	
5	Tray for packing	Polystyrene with anti-static treatment +anti-static polystyrene	
6	OPP tape	Polypropylene	
7	Protective bag	Polyethylene with anti-static treatment +anti-static polyethylene	



SPEC No. LCY-303Z01

 $\begin{array}{c} \text{MODEL} \quad \text{No.} \\ LQ022B8UD04 \end{array}$

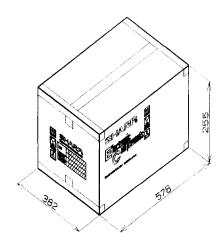
PAGE

21

TYPE	####:(45)LQ022B8UD04 LotNO. :(11)2003.xx.xx Quantity:(Q)250 PCS			
QUANTITY				
LOT (DATE)	 シャープ教育研ラベルです。(

[Quantities]

- 1 tray : 25 modules(max)
- 1 sleeve: 125 modules(NAX)
- 1 carton:250 modules(NAX)



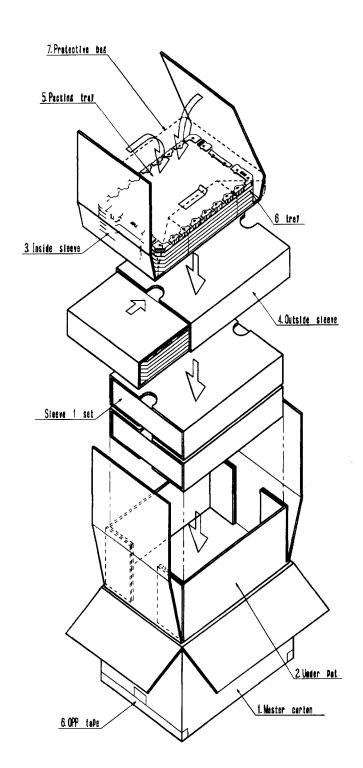


Fig.11

SPEC No.

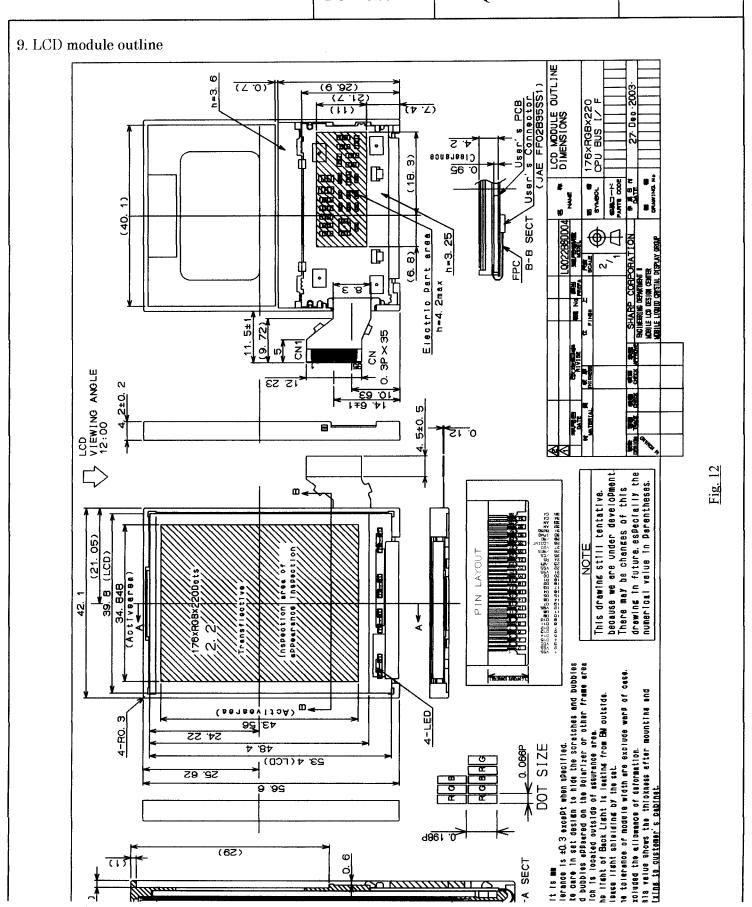
LCY-303Z01

MODEL No.

LQ022B8UD04

PAGE

22



SPECIFICATIONS ARE SUBJECT TO CHANGE WITHOUT NOTICE.

Suggested applications (if any) are for standard use; See Important Restrictions for limitations on special applications. See Limited Warranty for SHARP's product warranty. The Limited Warranty is in lieu, and exclusive of, all other warranties, express or implied. ALL EXPRESS AND IMPLIED WARRANTIES, INCLUDING THE WARRANTIES OF MERCHANTABILITY, FITNESS FOR USE AND FITNESS FOR A PARTICULAR PURPOSE, ARE SPECIFICALLY EXCLUDED. In no event will SHARP be liable, or in any way responsible, for any incidental or consequential economic or property damage.



NORTH AMERICA

SHARP Microelectronics of the Americas 5700 NW Pacific Rim Blvd. Camas, WA 98607, U.S.A. Phone: (1) 360-834-2500 Fax: (1) 360-834-8903

Fast Info: (1) 800-833-9437 www.sharpsma.com

TAIWAN

SHARP Electronic Components (Taiwan) Corporation 8F-A, No. 16, Sec. 4, Nanking E. Rd. Taipei, Taiwan, Republic of China Phone: (886) 2-2577-7341

Fax: (886) 2-2577-7326/2-2577-7328

CHINA

SHARP Microelectronics of China (Shanghai) Co., Ltd. 28 Xin Jin Qiao Road King Tower 16F Pudong Shanghai, 201206 P.R. China Phone: (86) 21-5854-7710/21-5834-6056 Fax: (86) 21-5854-4340/21-5834-6057 **Head Office:**

No. 360, Bashen Road, Xin Development Bldg. 22 Waigaoqiao Free Trade Zone Shanghai 200131 P.R. China Email: smc@china.global.sharp.co.jp

EUROPE

SHARP Microelectronics Europe Division of Sharp Electronics (Europe) GmbH Sonninstrasse 3 20097 Hamburg, Germany Phone: (49) 40-2376-2286 Fax: (49) 40-2376-2232

SINGAPORE

www.sharpsme.com

SHARP Electronics (Singapore) PTE., Ltd. 438A, Alexandra Road, #05-01/02 Alexandra Technopark, Singapore 119967 Phone: (65) 271-3566 Fax: (65) 271-3855

HONG KONG

SHARP-ROXY (Hong Kong) Ltd. 3rd Business Division, 17/F, Admiralty Centre, Tower 1 18 Harcourt Road, Hong Kong Phone: (852) 28229311 Fax: (852) 28660779 www.sharp.com.hk

Shenzhen Representative Office:

Room 13B1, Tower C, Electronics Science & Technology Building Shen Nan Zhong Road Shenzhen, P.R. China

Phone: (86) 755-3273731 Fax: (86) 755-3273735

JAPAN

SHARP Corporation Electronic Components & Devices 22-22 Nagaike-cho, Abeno-Ku Osaka 545-8522, Japan Phone: (81) 6-6621-1221 Fax: (81) 6117-725300/6117-725301 www.sharp-world.com

KOREA

SHARP Electronic Components (Korea) Corporation RM 501 Geosung B/D, 541 Dohwa-dong, Mapo-ku Seoul 121-701, Korea Phone: (82) 2-711-5813 ~ 8

Fax: (82) 2-711-5819